

NOTE: This order is nonprecedential.

United States Court of Appeals for the Federal Circuit

2009-1460, -1461, -1462, -1465

SPANSION, INC. and SPANSION, LLC,

Appellants,

and

FREESCALE SEMICONDUCTOR, INC.,

Appellant,

and

ATI TECHNOLOGIES, ULC,

Appellant,

and

STMICROELECTRONICS N.V.,

Appellant,

and

QUALCOMM INCORPORATED,

Appellant,

v.

INTERNATIONAL TRADE COMMISSION,

Appellee,

and

TESSERA, INC.,

Intervenor.

On appeal from the United States International Trade Commission in
Investigation No. 337-TA-605.

ON MOTION

Before PROST, Circuit Judge.

ORDER

Tessera, Inc. moves for leave to submit a surreply in connection with the stay motions of Spansion, Inc. et al. (Spansion) and Freescale Semiconductor, Inc. et al. and Qualcomm Incorporated. Spansion opposes.

Upon consideration thereof,

IT IS ORDERED THAT:

The motion is denied.

FOR THE COURT

AUG 13 2009

Date

/s/ Jan Horbaly

Jan Horbaly
Clerk

cc: Paul D. Clement, Esq.
Morgan Chu, Esq.
Megan Valentine, Esq.
Carter G. Phillips, Esq.
Russell E. Levine, Esq.
Kenneth R. Adamo, Esq.
Stephen B. Kinnaird, Esq.
Michael J. Bettinger, Esq.

s17

FILED
U.S. COURT OF APPEALS FOR
THE FEDERAL CIRCUIT

AUG 13 2009

**JAN HORBALY
CLERK**